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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	ARM® Cortex®-R4F
Core Size	32-Bit Single-Core
Speed	450MHz
Connectivity	CANbus, CSI, EBI/EMI, Ethernet, I ² C, SPI, UART/USART, USB
Peripherals	DMA, POR, PWM, WDT
Number of I/O	209
Program Memory Size	-
Program Memory Type	ROMless
EEPROM Size	-
RAM Size	1.5M x 8
Voltage - Supply (Vcc/Vdd)	1.14V ~ 3.6V
Data Converters	A/D 24x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	320-FBGA
Supplier Device Package	320-FBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r7s910006cbg-ac0

Table 1.1 Outline of Specifications (2 / 7)

Classification	Module/Function	Description
Low power	Low power consumption	- Standby mode (Cortex-R4) - Sleep mode (Cortex-M3) (for products incorporating an R-IN engine) - Module stop function
Interrupt	Cortex-R4 vector interrupt controller (VIC)	- Peripheral function interrupts: 273 sources / 276 sources (for products incorporating an R-IN engine) - External interrupts: 20 sources (NMI, IRQ0 to IRQ15, ETH0_INT, ETH1_INT, and ETH2_INT pins) - Software interrupts: 1 source - Non-maskable interrupts: 2 sources - Sixteen levels specifiable for the order of priority
	Cortex-M3 nested-type vector interrupt controller (NVIC) (only included in products incorporating an R-IN engine)	- Peripheral function interrupts: 82 sources - External interrupts: 19 sources (IRQ0 to IRQ15, ETH0_INT, ETH1_INT, and ETH2_INT pins) - Software interrupts: 1 source - Non-maskable interrupts: 1 source - Sixteen levels specifiable for the order of priority
External bus extension	Bus state controller (BSC)	- The external address space is divided into six areas (CS0 to CS5) for management. - The following features settable for each area independently. Bus size (8, 16, or 32 bits): Available sizes depend on the area. Number of access wait cycles (different wait cycles can be specified for read and write access cycles in some areas) Idle wait cycle insertion (between same area access cycles or different area access cycles) Specifying the memory to be connected to each area enables direct connection to SRAM, SRAM with byte selection, SDRAM, and burst ROM (clocked synchronous or asynchronous). The address/data multiplexed I/O (MPX) interface is also available. - Outputs a chip select signal (CS0# to CS5#) according to the target area (CS assert or negate timing can be selected by software) - SDRAM refresh Auto refresh or self-refresh mode selectable - SDRAM burst access
Data transfer	Direct memory access controller (DMAC)	2 units (16 channels for unit 0, 16 channels for unit 1) - Transfer modes: Single transfer mode and block transfer mode - Transfer size Unit 0: 1/2/4/16/32/64 bytes Unit 1: 1/2/4/16 bytes - Activation sources: Software trigger, external DMA requests (DREQ0 to DREQ2), external interrupts, and interrupt requests from peripheral functions
I/O ports	General-purpose I/O ports	320-pin FBGA I/O pins: 209 Input pins: 9 Pull-up/pull-down resistors: 209 5-V tolerance: 9 176-pin HLQFP I/O pins: 97 Input pins: 5 Pull-up/pull-down resistors: 97 5-V tolerance: 5
Event link controller (ELC)		87 event signals can be interlinked with the operation of modules. - In particular, the operation of timer modules can be started by input event signals. - Event-linked operation of signals of ports B and E is to be possible.
Multi-function pin controller (MPC)		The locations of input/output functions are selectable from among multiple pins.

Table 1.5 Pin Assignments (320-Pin FBGA) (7 / 8)

Pin Number	Pin Name
V10	PH1 / A10 / MTIOC2B / PO11
V11	PH7 / A16 / MTIC5W
V12	P20 / A17 / MTCLKD
V13	P21 / IRQ1 / CS0# / MTIC5V / TIOCB1 / CTS0#
V14	VSS
V15	P45 / CS2#
V16	P46 / CKE
V17	PS2 / MTIOC7C / SSIWS0
V18	P05 / D5 / MTIOC3A
V19	P01 / D1 / MTIC5W / TIOCA2
V20	P02 / D2 / MTIC5V / TIOCA3
W1	P62 / SPBCLK
W2	P65 / SPBIO2 / DREQ0
W3	PN5 / IRQ5 / MTIOC6A / TIOCD9 / ENCIF10
W4	PN6 / MTIOC3C / TIOCC9 / MCLK3 / ENCIF11
W5	PP0 / POE8# / TEND0 / MCLK2
W6	PP2 / MTIOC0C / TCLKH / MCLK1
W7	PP4 / MTIOC0A / MCLK0
W8	PP6 / TIOCA11 / RXD1 / TRACECTL / ENCIF06
W9	PP7 / TCLKF / TCLKH / SCK1 / DACK1 / TRACECLK
W10	PR1 / IRQ9 / POE4# / CTS1# / TEND1 / TRACEDATA1 / ENCIF08
W11	PR3 / TIOCA10 / TIOCB10 / TRACEDATA3 / ENCIF01
W12	PR5 / TIOCA8 / TIOCB8 / TRACEDATA5 / ENCIF03
W13	P24 / IRQ12 / RD/WR# / RXD0
W14	P22 / IRQ2 / RD# / MTIOC7B / TIOCD0 / SCK0
W15	P44 / IRQ12 / WAIT# / TCLKD / ADTRG0 / CTS0#
W16	P43 / WE2#/DQMUL / MTIOC8B / USB_VBUSEN
W17	PS1 / IRQ1 / MTIOC7B / SSISCK0
W18	PS3 / MTIOC7A / SSIRXD0
W19	PS4 / MTIOC6D / SSITXD0
W20	PS5 / MTIOC6B
Y1	VSS
Y2	P67 / IRQ15 / GTIOC3B / CTXD0 / TEND0 / USB_OVRCUR
Y3	P66 / IRQ14 / GTIOC3A / CTXD1 / DACK0 / USB_VBUSEN
Y4	PN7 / MTIOC3A / TIOCD6 / DREQ0 / MDAT3 / ENCIF12
Y5	PP1 / MTIOC0D / DACK0 / MDAT2
Y6	PP3 / MTIOC0B / TCLKC / MDAT1
Y7	PP5 / PO22 / MDAT0
Y8	VSS
Y9	PR0 / TCLKE / TCLKG / TXD1 / DREQ1 / TRACEDATA0 / ENCIF07
Y10	PR2 / TIOCA11 / TIOCB11 / RTS1# / TRACEDATA2 / ENCIF00
Y11	PR4 / TIOCA9 / TIOCB9 / TRACEDATA4 / ENCIF02
Y12	PR6 / TIOCA7 / TIOCB7 / TRACEDATA6 / ENCIF04
Y13	PR7 / TIOCA6 / TIOCB6 / TRACEDATA7 / ENCIF05
Y14	P25 / A18 / MTCLKC / TEND1

Table 1.7 List of Pin and Pin Functions (320-Pin FBGA) (3 / 10)

Pin Number	Power Supply Clock System Control	I/O Port	Bus	Timer (MTU3a, GPTa, TPUa, PPG, POE3, CMTW)	Communication (ETHERC, ECATC*1, SCIFA, RSPIa, RIIa, RSCAN, SPIBSC, USB)	Others (SSI, DSMIF, Encoder I/F)	Interrupt	S12ADCa
C15								AN000
C16	VREFL0							
C17	VREFH0							
C18		PD2	WAIT#					AN110
C19		P14	CAS#	MTIOC4A / GTIOC1A		ENCIF10		
C20		P13	RAS#	MTIOC4C / GTIOC1B				
D1		P81		TIOCC0	ETH0_RXER / CTS4#			
D2		P80		TIOCC3	ETH0_RXDV / RTS4#		IRQ8	
D3		PU3		TIOCD6	ETH2_COL / TXD3			
D18		PD0	CS4#					AN108
D19		P96		POE0# / POE10#		ENCIF09		AN106
D20		P95		MTCLKA	CTS2#		IRQ13	AN105
E1		P84			ETH0_COL / CATLINKACT1 / RXD4			
E2		P82		TIOCD3	ETH0_TXEN / ETH1_CRS / SCK4 / RTS3# / USB_OVRCUR			
E3		PU1		TIOCA11	ETH2_RXC / SCK3			
E5		PU0		TIOCA10	ETH2_RXER			
E6		PL6		TIOCA9	ETH2_RXD3			
E7		PL4			ETH2_RXD1		IRQ4	
E8		PL2		TIOCA6	ETH2_TXEN			ADTRG1
E9		PL0		TIOCB9	ETH2_TXD0			
E10		PK7		TIOCB7	ETH2_TXD2			
E11		PK6		TIOCB6	ETH2_TXD3			
E12		PD5	A21	TIC0	ETH1_TXD3 / ETH0_TXD0 / SSL20	MCLK3		AN113
E13		P56	BS#		ETH1_TXER			
E14		PD4			ETH2_INT			AN112
E15	VCCQ33							
E16		PD1	CS1#					AN109
E18		P97	A25				IRQ7	ADTRG1 / AN107
E19		P94		MTCLKB	RTS2#	ENCIF08	IRQ4	AN104
E20		P93		MTIOC1A / TIC3	SCK2	ENCIF07		AN103
F1		PC4		TCLKH	CAT12CCLK / SCL0			
F2		P83			ETH0_CRS / CATLINKACT0 / TXD4		IRQ11	

Table 1.7 List of Pin and Pin Functions (320-Pin FBGA) (6 / 10)

Pin Number	Power Supply Clock	I/O Port	Bus	Timer (MTU3a, GPTa, TPUa, PPG, POE3, CMTW)	Communication (ETHERC, ECATC*1, SCIFA, RSPIa, RIIa, RSCAN, SPIBSC, USB)	Others (SSI, DSMIF, Encoder I/F)	Interrupt	S12ADCa
K18	TRACEDATA4	P76	D22	MTIOC4B / GTIOC2A	SSL01	SSIWS0		
K19	TRACEDATA3	P75	D21	MTIOC4D / GTIOC2B	SSL00	ENCIF04	IRQ13	
K20		PT5	BS# / TEND2	PO30				
L1	MD1							
L2	MD2							
L3	TMS							
L5	TCK							
L6	PLLVS1							
L8	VDD							
L9	VSS							
L10	VSS							
L11	VSS							
L12	VSS							
L13	VDD							
L15	VSS							
L16	TRACEDATA7	PE7	D15	MTIOC7A / TIOC3 / POE8#	SCK1 / RSPCK0			
L18	TRACEDATA0	P72	D18	MTIOC1A / TIC2	TXD1	SSITXD0 / ENCIF02		
L19	TRACEDATA1	P73	D19	MTCLKB	RXD1	SSIRXD0 / ENCIF03	IRQ3	
L20	TRACEDATA2	P74	D20	MTCLKA	CTS1# / SSL03	SSISCK0		
M1	XTAL							
M2	EXTAL							
M3	OSCTH							
M5	BSCANP							
M6	PLLVDD0							
M8	VDD							
M9	VSS							
M10	VSS							
M11	VSS							
M12	VSS							
M13	VDD							
M15	VCCQ33							
M16	TRACEDATA6	PE6	D14	MTIOC0A / TIOC0	RXD1 / MISO0		IRQ6	
M18	TRACECLK	P70	D16	MTIOC6D	RTS1# / USB_OVRCUR	ENCIF00	IRQ0	
M19		PT4	CS3#	PO29				
M20	TRACECTL	P71	D17	POE0# / POE10# / TOC2	SCK1	ENCIF01		
N1	VSS							
N2	MD0							

Table 1.8 List of Pin and Pin Functions (176-Pin HLQFP) (1 / 6)

Pin Number	Power Supply Clock System Control	I/O Port	Bus	Timer (MTU3a, GPTa, TPUa, PPG, POE3, CMTW)	Communication (ETHERC, SCIFA, RSPIa, RIICa, RSCAN, SPIBSC, USB)	Others (SSI, DSMIF) Interrupt S12ADCa
1		PC3			ETH0_RXC / ETH0_RXDV / RXD4 / SCL0 / CRXD1	
2	VCCQ33					
3	VSS					
4	VDD					
5		P82		TIOCD3	ETH0_TXEN / ETH1_CRS / SCK4 / RTS3# / USB_OVRCUR	
6		P85			CLKOUT25M0 / TXD4 / SCK4 / USB_VBUSEN	IRQ5
7	ERROROUT #					
8		P35				NMI
9	TRST#					
10	TDO	P33				
11	TDI	P34				
12	TMS					
13	TCK					
14	BSCANP					
15	VDD					
16	VSS					
17	MD2					
18	MD1					
19	PLLVD1					
20	PLLVS1					
21	OSC1H					
22	VCCQ33					
23	EXTAL					
24	XTAL					
25	VSS					
26	MD0					
27	PLLVD0					
28	PLLVS0					
29	RES#					
30	RSTOUT#					
31	VDD					
32	VSS					
33	VDD33_USB					
34	VSS_USB					
35	USB_RREF					

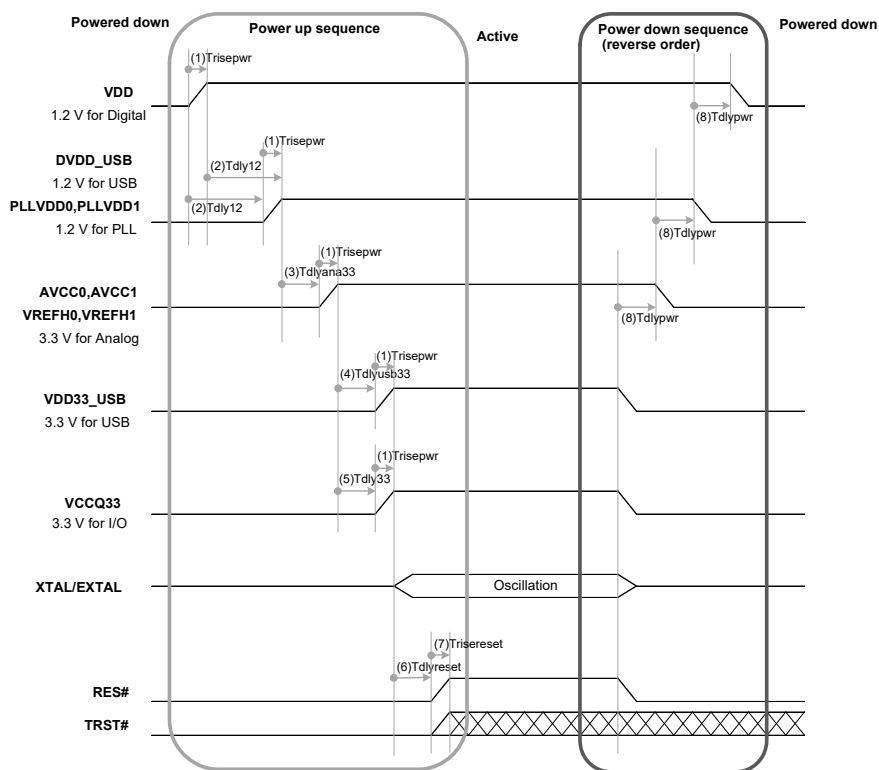
Table 1.8 List of Pin and Pin Functions (176-Pin HLQFP) (4 / 6)

Pin Number	Power Supply Clock System Control	I/O Port	Bus	Timer (MTU3a, GPTa, TPUa, PPG, POE3, CMTW)	Communication (ETHERC, SCIFA, RSPIa, RIICa, RSCAN, SPIBSC, USB)	Others (SSI, DSMIF) Interrupt S12ADCa
106	TRACEDATA 7	PE7	D15	MTIOC7A / TIOC3D / POE8#	SCK1 / RSPCK0	
107	VSS					
108	VDD					
109	TRACECLK	P70	D16	MTIOC6D	RTS1# / USB_OVRCUR	IRQ0
110	TRACECTL	P71	D17	POE0# / POE10# / TOC2	SCK1	
111	TRACEDATA 0	P72	D18	MTIOC1A / TIC2	TXD1	SSITXD0
112	TRACEDATA 1	P73	D19	MTCLKB	RXD1	SSIRXD0 IRQ3
113	TRACEDATA 2	P74	D20	MTCLKA	CTS1# / SSL03	SSISCK0
114	TRACEDATA 3	P75	D21	MTIOC4D / GTIOC2B	SSL00	IRQ13
115	TRACEDATA 4	P76	D22	MTIOC4B / GTIOC2A	SSL01	SSIWS0
116	TRACEDATA 5	P77	D23	MTIOC4C / GTIOC1B	RSPCK0	
117	TRACEDATA 6	PA0	D24	MTIOC4A / GTIOC1A	MOSI0	MDAT3
118	TRACEDATA 7	PA1	D25	MTIOC3D / GTIOC0B	MISO0	AUDIO_CLK / MCLK3
119	VSS					
120	VDD					
121		PA2	D26 / DREQ2	MTIOC3B / GTIOC0A	SSL02	MDAT2
122		PA3	D27 / DACK2	GTETRG / TIOCA2	ETHSWSECOUT / SCK2	MCLK2
123		PA4	D28 / TEND2	TIOCA3	ETH1_INT / RXD2	MDAT1 ADTRG0
124		PA5	D29	TIOCA4	ETH0_INT / ETH1_TXER / TXD2	MCLK1
125		PA6	D30 / A21	GTIOC3A	CTS2#	MDAT0 IRQ6
126	VCCQ33					
127		PA7	D31 / A22	MTIOC6B / GTIOC3B	RTS2#	MCLK0 IRQ7
128	VDD					
129	VSS					
130		P13	RAS#	MTIOC4C / GTIOC1B		
131		P14	CAS#	MTIOC4A / GTIOC1A		
132		P15	CS3# / CKE	MTIOC3D / GTIOC0B		
133		P16	CS4# / CS2#	MTIOC3B / GTIOC0A		

2.2 Power On/Off Sequence

Turn on and off each power supply voltage according to the procedure shown in the figure below.

When turning on the power, be sure to fix TRST# pins and RES# pins to the low level. Otherwise, initialization is not performed successfully.



Timing

No.	Item	Value		
		min	typ	max
(1)	Trisepwr	100 μ s	—	50 ms
(2)	Tdly12	0 ms	—	100 ms
(3)	Tdlyana33	0 ms	—	100 ms
(4)	Tdlyusb33	0 ms	—	100 ms
(5)	Tdly33	0 ms	—	100 ms
(6)	Tdlyreset	10 ms	—	—
(7)	Trisereset	—	—	150 μ s
(8)	Tdlypwr	0 ms	—	—

Note 1. Turn on all power supply voltages and reset signals with a monotonic increase and turn off with a monotonic decrease.

Note 2. Do not apply a negative voltage to power supply voltages.

Note 3. Before turning on the power, be sure to make reset pins (TRST# and RES#) active (low). Otherwise, inputs and outputs on the pins may be unstable. If this may also be a problem when turning off the power, make reset pins (TRST# and RES#) active (low.)

Note: If the power on/off sequence is not met (out of operation guarantee range), the pin input state and output state may be undefined.

Figure 2.1 Power On/Off Sequence

Table 2.9 Permissible Output Currents

Item		Symbol	min	typ	max	Unit
Permissible output low current (average value per pin)	Other than 5-V tolerant pins	I_{OL1}	—	—	2.0	mA
	5-V tolerant pins	I_{OL2}	—	—	3.0	mA
Permissible output low current (maximum value per pin)	Other than 5-V tolerant pins	I_{OL1}	—	—	4.0	mA
	5-V tolerant pins	I_{OL2}	—	—	6.0	mA
Permissible output low current (total)	Total of all output pins	ΣI_{OL}	—	—	80	mA
Permissible output high current (average value per pin)	All output pins	I_{OH}	—	—	−2.0	mA
Permissible output high current (maximum value per pin)	All output pins	I_{OH}	—	—	−4.0	mA
Permissible output high current (total)	Total of all output pins	ΣI_{OH}	—	—	−80	mA

[Usage Notes] All output current values shall be within the values in Table 2.9 to ensure the reliability of this LSI.

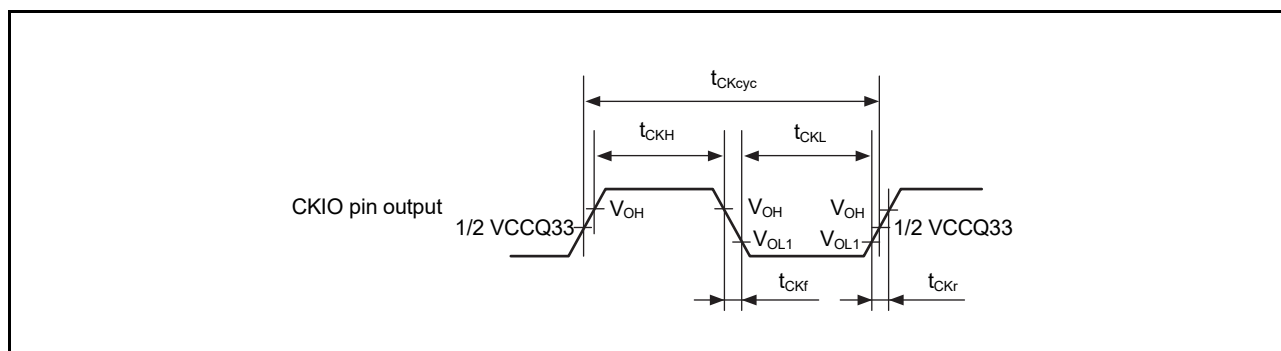
2.4.1 Clock Timing

Table 2.11 CKIO Pin Output Timing

Output load condition: C = 30 pF

Item	Symbol	min	typ	max	Unit	Test Conditions
CKIO pin output cycle time	t_{CKcyc}	13.3	—	53.4	ns	Figure 2.2
CKIO pin output high level pulse width	t_{CKH}	$t_{CKcyc}/2 - t_{CKr}$	—	—	ns	
CKIO pin output low level pulse width	t_{CKL}	$t_{CKcyc}/2 - t_{CKf}$	—	—	ns	
CKIO pin output rising time 1	t_{CKr}	—	—	5	ns	CKIO: High drive output setting*1 $V_{OH} = V_{CCQ33} - 0.5\text{ V}$ $V_{OL1} = 0.4\text{ V}$
CKIO pin output falling time 1	t_{CKf}	—	—	5	ns	
CKIO pin output rising time 2	t_{CKr}	—	—	9	ns	CKIO: Normal output setting $V_{OH} = V_{CCQ33} - 0.5\text{ V}$ $V_{OL1} = 0.4\text{ V}$
CKIO pin output falling time 2	t_{CKf}	—	—	9	ns	
CKIO pin output rising time 3	t_{CKr}	—	—	2.5	ns	CKIO: High drive output setting*1 $V_{OH} = 2.0\text{ V}$ $V_{OL1} = 0.8\text{ V}$
CKIO pin output falling time 3	t_{CKf}	—	—	2.5	ns	
CKIO pin output rising time 4	t_{CKr}	—	—	4.5	ns	CKIO: Normal output setting $V_{OH} = 2.0\text{ V}$ $V_{OL1} = 0.8\text{ V}$
CKIO pin output falling time 4	t_{CKf}	—	—	4.5	ns	

Note 1. When connecting SDRAM, be sure to set the B0 bit in the drive capacity control register (DSCR) to 1 to be a high drive output.

**Figure 2.2 CKIO Pin Output Timing**

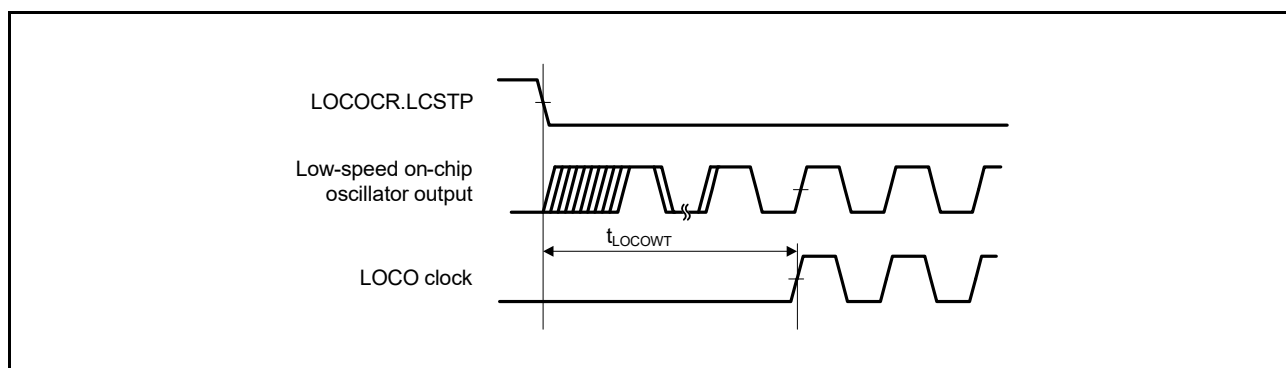
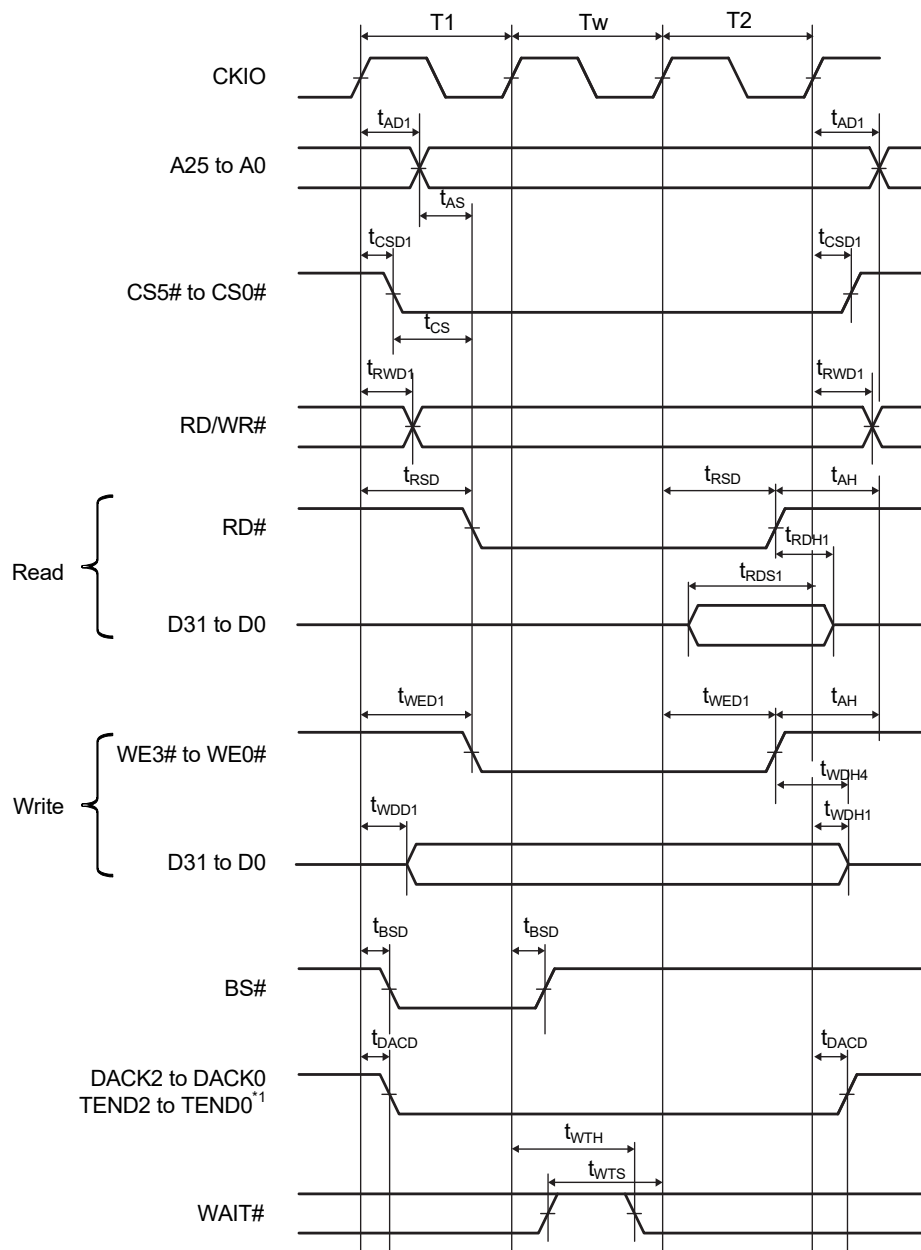
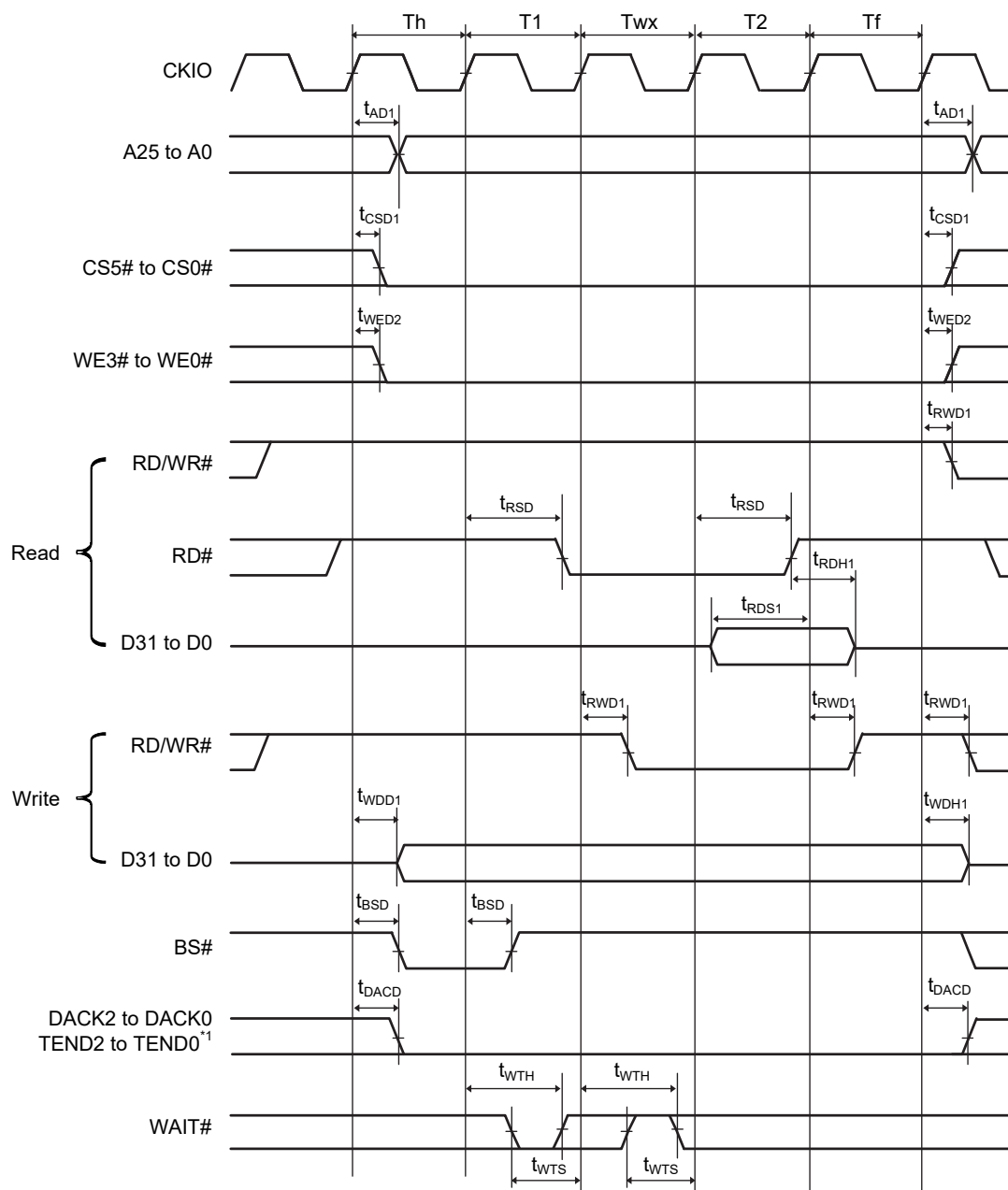


Figure 2.7 LOCO Clock Oscillation Start Timing



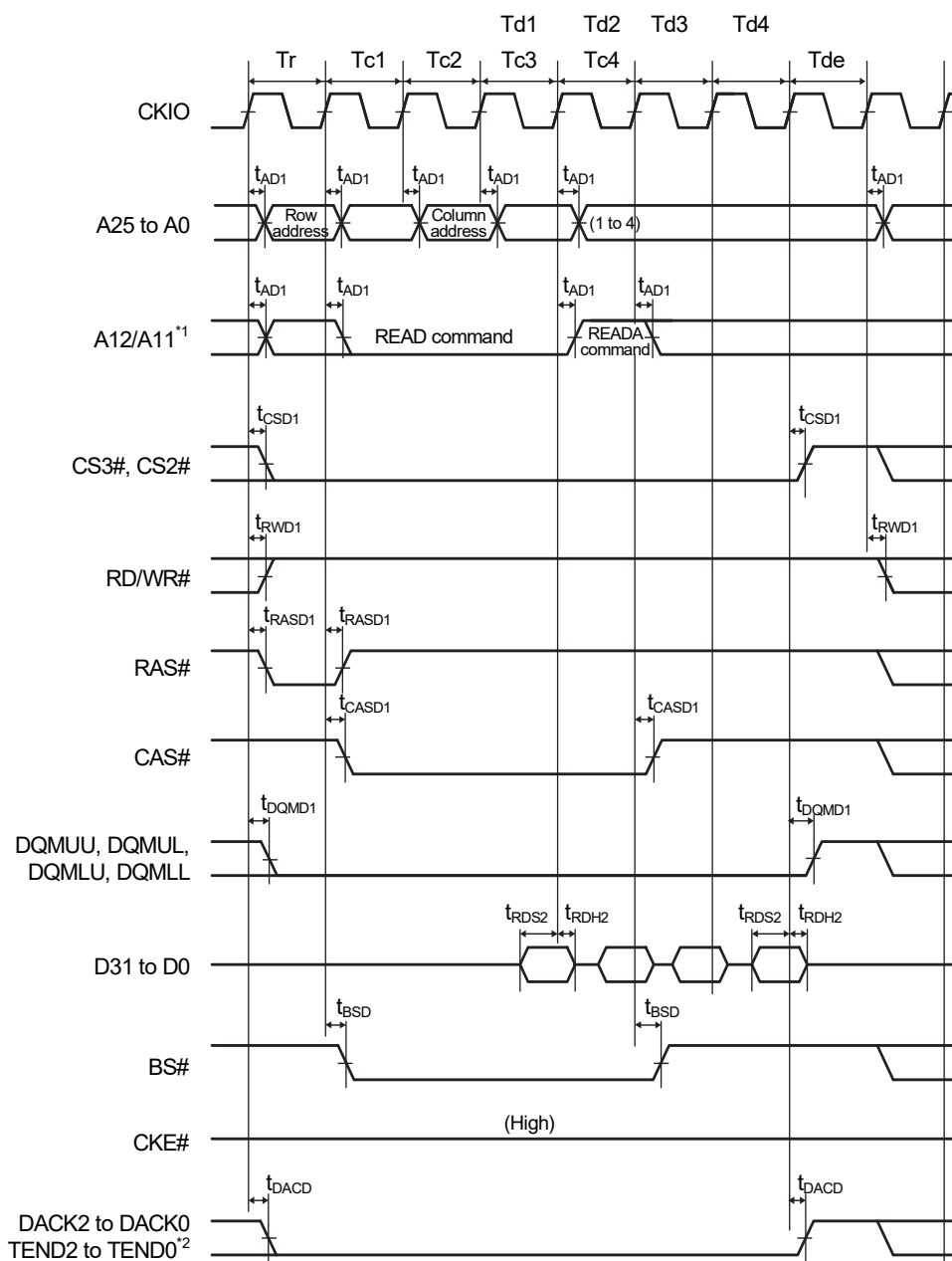
Note 1. DACKn and TENDn are waveforms when "active low" is specified.

Figure 2.13 SRAM Interface Basic Bus Cycle (Software Wait 1)



Note 1. DACKn and TENDn are waveforms when "active low" is specified.

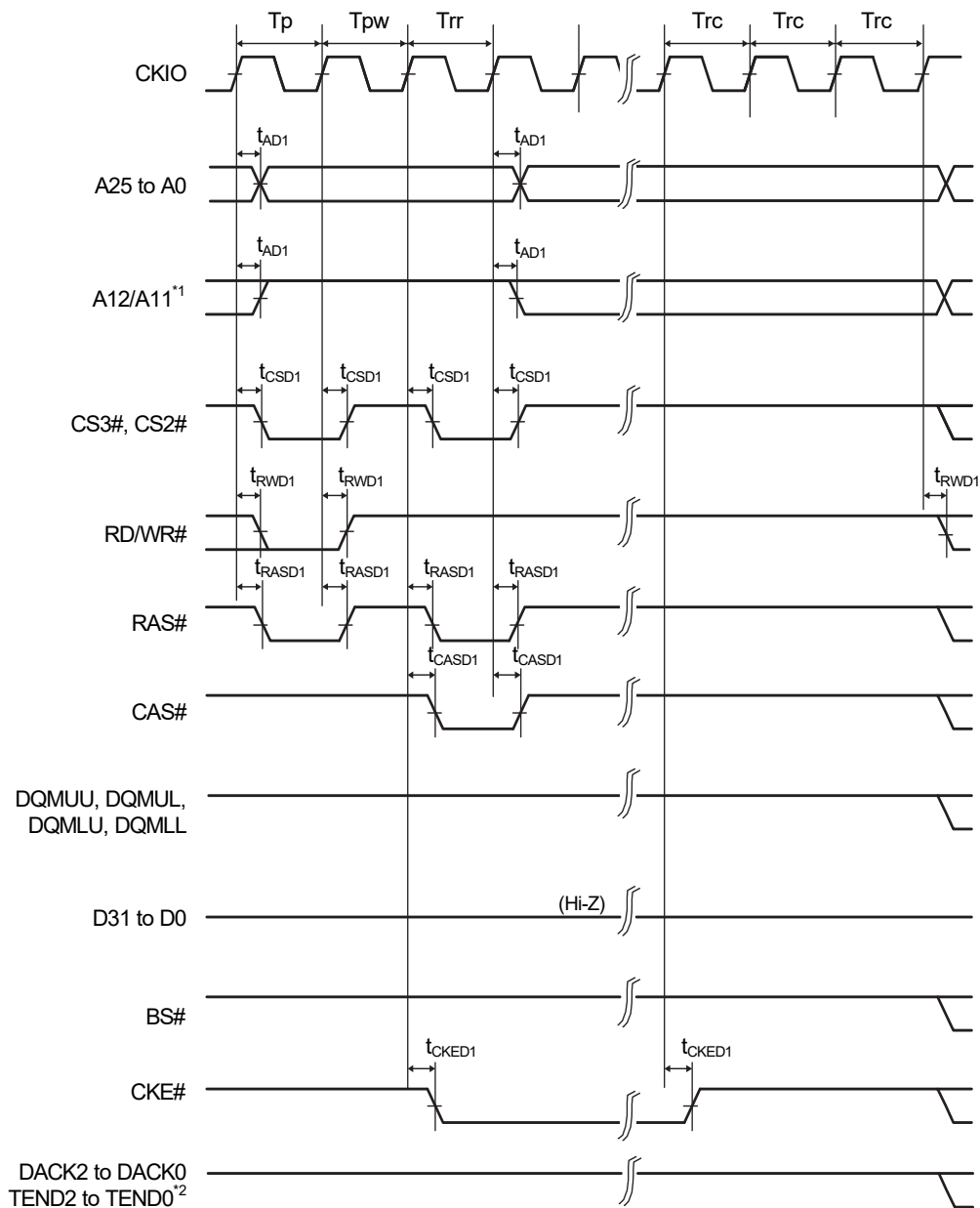
Figure 2.18 SRAM Bus Cycle with Byte Selection (SW = 1 Cycle, HW = 1 Cycle, Asynchronous External Wait 1 Inserted, BAS = 1 (Write Cycle WE Control))



Note 1. Address pin to be connected to A10 of SDRAM

Note 2. DACKn and TENDn are waveforms when "active low" is specified.

Figure 2.22 Synchronous DRAM Burst-Read Bus Cycle (Read for 4 Cycles) (with Auto Precharge, CAS Latency 2, WTRCD = 0 Cycles, WTRP = 1 Cycle)



Note 1. Address pin to be connected to A10 of SDRAM

Note 2. DACKn and TENDn are waveforms when "active low" is specified.

Figure 2.35 Synchronous DRAM Self-Refresh Timing (WTRP = 1 Cycle)

2.4.4 DMAC Timing

Table 2.18 DMAC Timing

Output load conditions: $V_{OH} = V_{CCQ33} \times 0.5$, $V_{OL1} = V_{CCQ33} \times 0.5$, $C = 30 \text{ pF}$

Item	Symbol	min*1	max	Unit	Test Conditions
DMAC	DREQ pulse width	t_{DRQW}	—	ns	Figure 2.37
	DACK and TEND delay time	t_{DADC}	10	ns	Figure 2.38

Note 1. t_{PBcyc} : PCLKB cycle

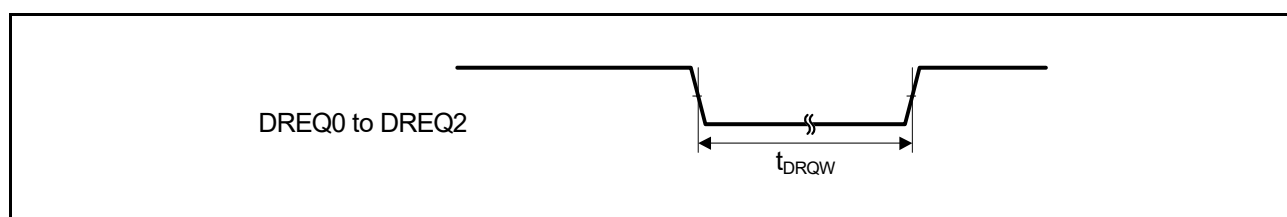


Figure 2.37 DREQ Input Timing

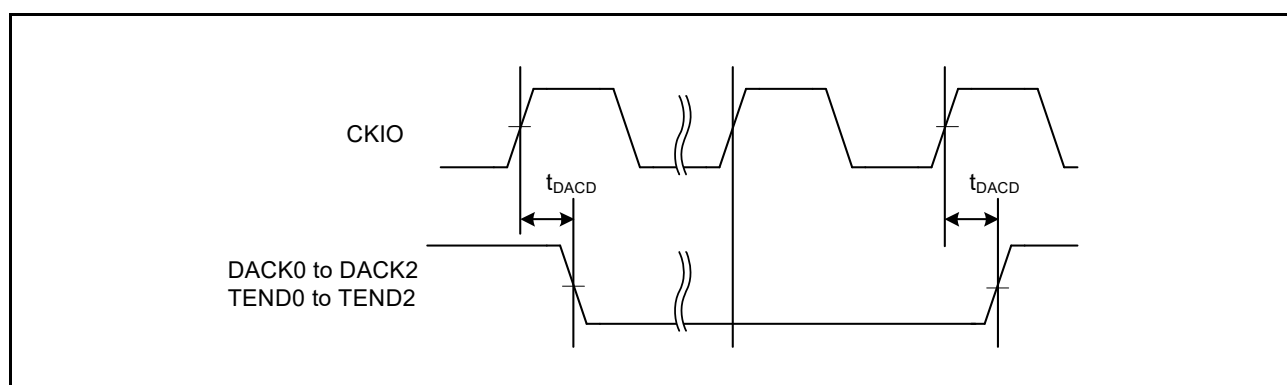
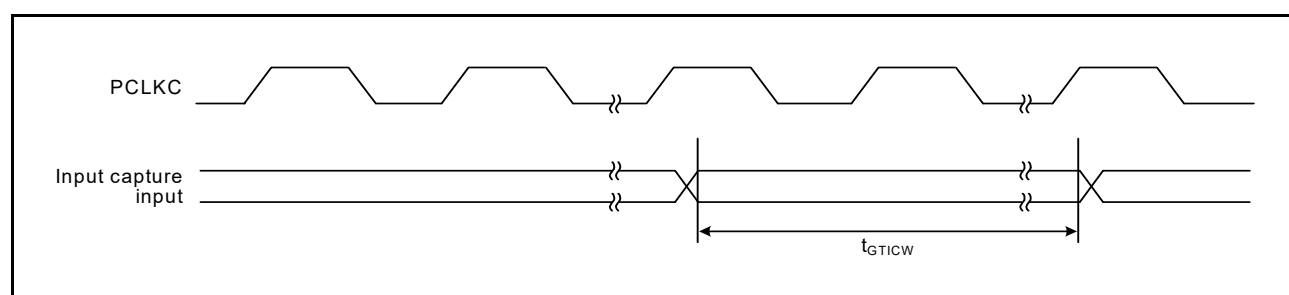
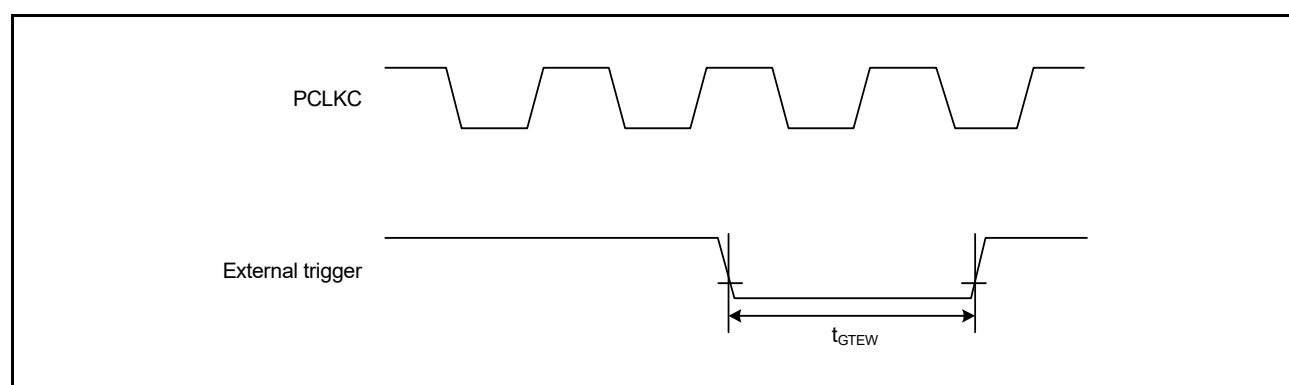


Figure 2.38 DACK and TEND Output Timing

2.4.5.6 GPTa Timing

Table 2.24 GPTa Timing

Item			Symbol	min	max	Unit*1	Test Conditions
GPTa	Input capture input pulse width	Single-edge setting	t_{GTICW}	3	—	t_{PCyc}	Figure 2.46
		Both-edge setting		5	—		
	External trigger input pulse width	Single-edge setting	T_{OTETW}	1.5	—	t_{PCyc}	Figure 2.47
		Both-edge setting		2.5	—		

Note 1. t_{PCyc} : PCLKC cycle**Figure 2.46 GPTa Input Capture Input Timing****Figure 2.47 GPTa External Trigger Input Timing**

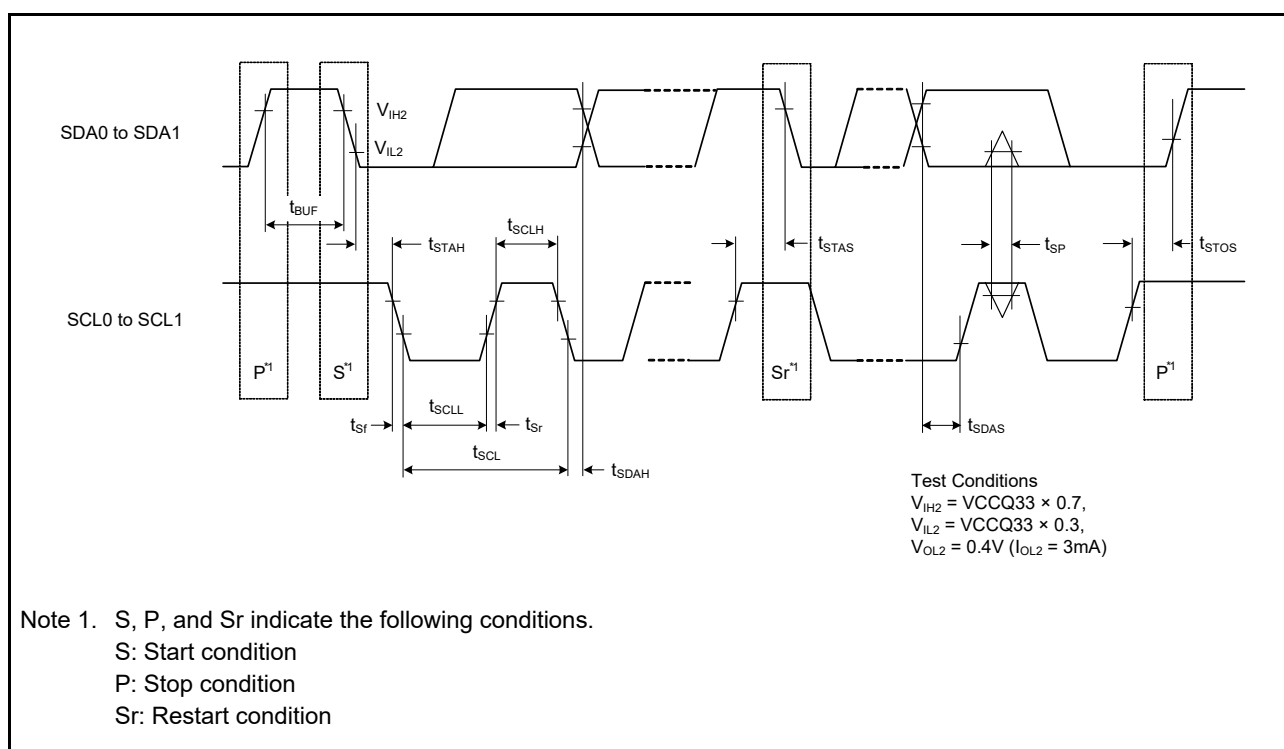


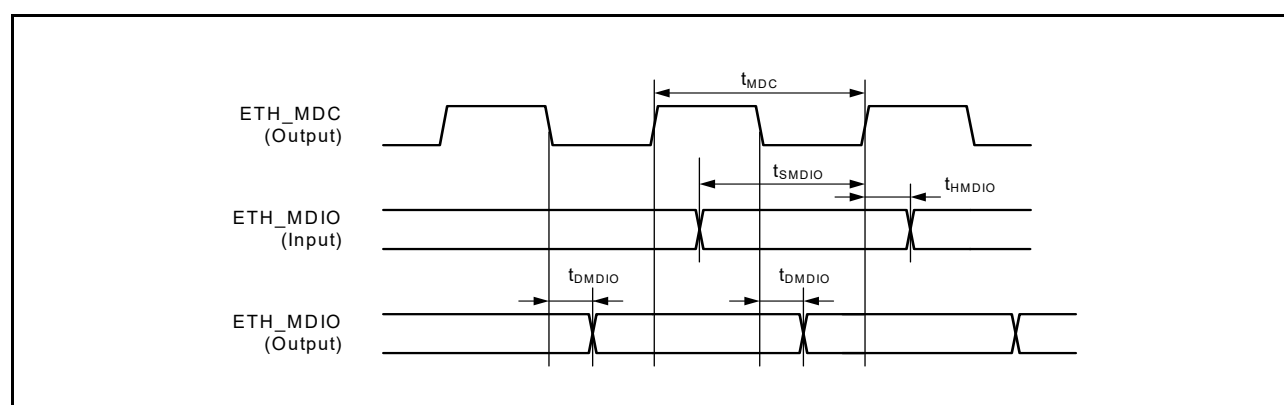
Figure 2.64 IICa Bus Interface Input/Output Timing

2.4.5.15 Serial Management Interface Timing

(1) Timing

Table 2.33 Serial Management InterfaceOutput load conditions: $V_{OH} = V_{CCQ33} \times 0.5$, $V_{OL1} = V_{CCQ33} \times 0.5$, $C = 30$ pF

Item	Symbol	min	max	Unit	Test Conditions
MDIO	ETHn_MDC output cycle	t_{MDC}	80	—	ns
	ETHn_MDIO input setting time (to ETHn_MDC↑)	t_{SMDIO}	10	—	ns
	ETHn_MDIO input hold time (to ETHn_MDC↑)	t_{HMDIO}	0	—	ns
	ETHn_MDIO output delay time (to ETHn_MDC↓)	t_{DMDIO}	20	—	ns

**Figure 2.78 Serial Management Access Timing**

2.5 USB Characteristics

- Conditions: $V_{DD} = PLLVDD0 = PLLVDD1 = DVDD_USB = 1.14$ to 1.26 V,
 $VCCQ33 = AVCC0 = AVCC1 = VREFH0 = VREFH1 = VDD33_USB = 3.0$ to 3.6 V
 $VSS = PLLVSS0 = PLLVSS1 = AVSS0 = AVSS1 = VREFL0 = VREFL1 = VSS_USB = 0$ V,
 $T_j = -40$ to 125 °C

Note: The 176-pin HLQFP does not have pins AVCC1, AVSS1, VREFH1, and VREFL1.

Table 2.35 On-chip USB Full-Speed Characteristics (USB_DP, USB_DM Pin Characteristics)

Item	Symbol	min	typ	max	Unit	Test Conditions
Rising time	t_{FR}	4	—	20	ns	Figure 2.82
Falling time	t_{FF}	4	—	20	ns	
Rising/falling time ratio	t_{FR} / t_{FF}	90	—	111.11	%	t_{FR} / t_{FF}

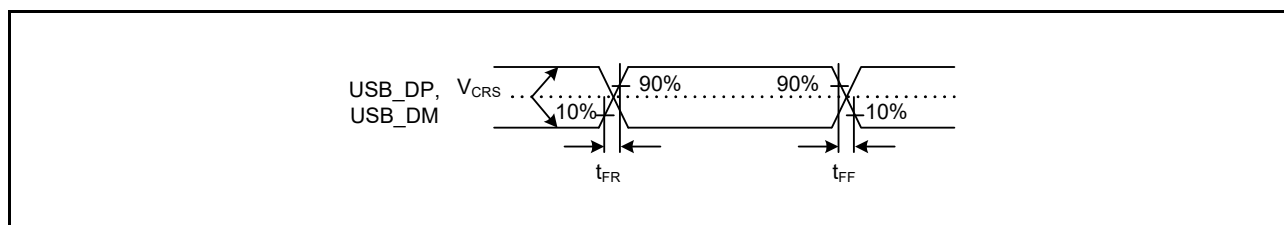


Figure 2.82 USB_DP, USB_DM Output Timing (Full Speed)

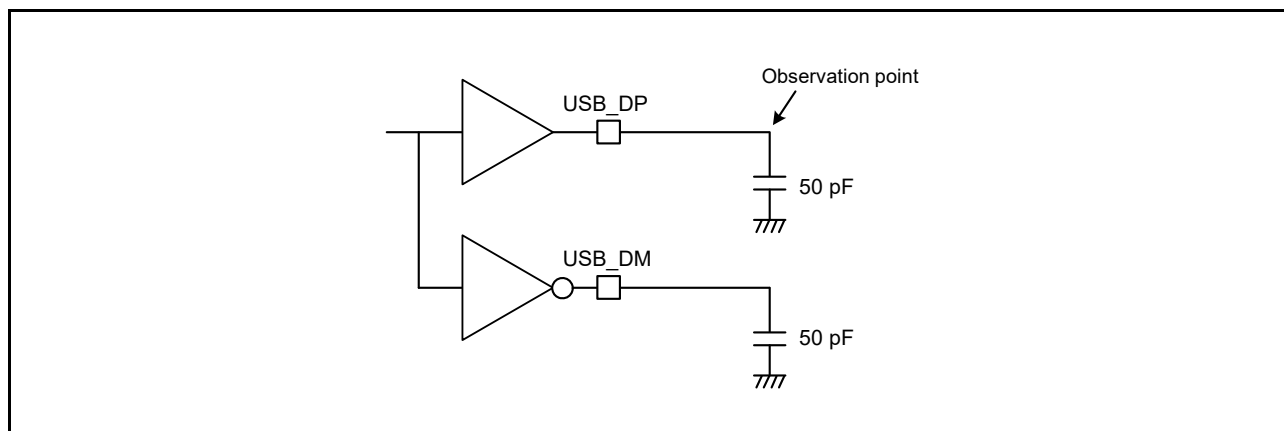


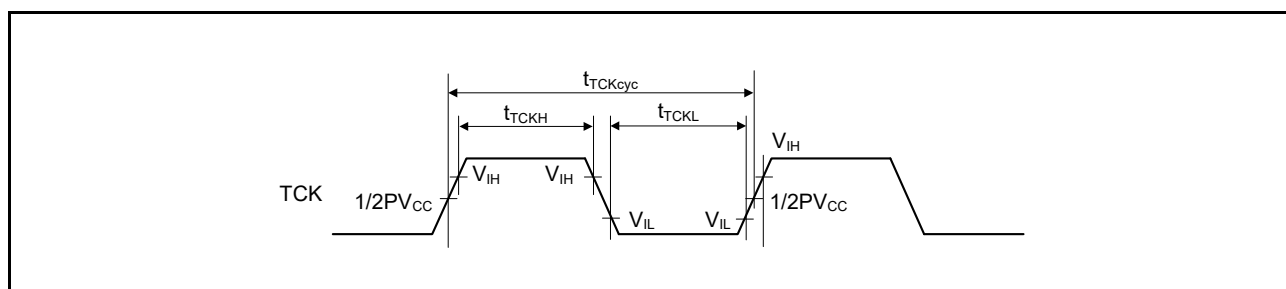
Figure 2.83 Measurement Circuit (Full Speed)

2.9 Debug Interface Timing

Table 2.41 Debug Interface Timing

Output load conditions: $V_{OH} = V_{CCQ33} - 0.5\text{ V}$, $V_{OL1} = 0.4\text{ V}$

Item	Symbol	Min.	Max.	Unit	Reference Figure
TCK cycle time	t_{TCKcyc}	30	—	ns	Figure 2.87
TCK high pulse width	t_{TCKH}	0.4	0.6	t_{TCKcyc}	
TCK low pulse width	t_{TCKL}	0.4	0.6	t_{TCKcyc}	
TDI setup time	t_{TDIS}	5	—	ns	Figure 2.88 Output load: 30 pF
TDI hold time	t_{TDIH}	5	—	ns	
TMS/SWDIO setup time	t_{TMSS}	5	—	ns	
TMS/SWDIO hold time	t_{TMSH}	5	—	ns	
SWDIO delay time	t_{SWDO}	—	15	ns	
TDO delay time	t_{TDOD}	—	15	ns	Figure 2.89
Capture register setup time	t_{CAPTS}	5	—	ns	
Capture register hold time	t_{CAPTH}	5	—	ns	
Update register delay time	$t_{UPDATED}$	—	15	ns	
Trace clock cycle	t_{TCYC}	26.6	—	ns	Figure 2.90 Output load: 15 pF
Trace data delay time	t_{TDT}	$0.25 \times t_{TCYC} - 2$	$0.25 \times t_{TCYC} + 2$	ns	


Figure 2.87 TCK Input Timing